



300mA Micropower µCap Baseband LDO

#### **General Description**

The MIC5307 is a micropower,  $\mu$ Cap low dropout regulator designed for optimal performance where smaller packages are required. It is capable of sourcing 300mA of output current while only drawing 20 $\mu$ A of operating current. This high performance LDO offers fast transient response and good PSRR while consuming a minimum of current.

Ideal for battery operated applications; the MIC5307 offers 1% initial accuracy, extremely low dropout voltage and is equipped with a TTL logic compatible enable pin. The MIC5307 can be put into a zero-off-mode current state, drawing no current when disabled.

The MIC5307 is a  $\mu$ Cap design, operating with very small ceramic output capacitors for stability, reducing required board space and component cost.

The MIC5307 is available in fixed output voltages in the Thin SOT23-5 package and the 6-pin 2mm x 2mm Thin  $MLF^{\$}$  package.

Data sheets and support documentation can be found on Micrel's web site at www.micrel.com.

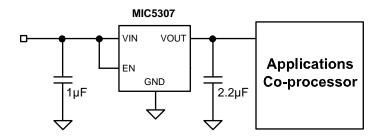
#### Features

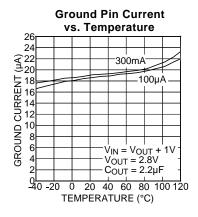
- Input voltage range: 2.4V to 5.5V
- Ultra-low IQ: Only 20µA operating current
- Stable with ceramic output capacitor
- Low dropout voltage of 120mV @ 300mA
- · High output accuracy
  - ±1.0% initial accuracy
  - ±2.0% over temperature
- Thermal Shutdown Protection
- Current Limit Protection

#### Applications

- Digital Logic Power Supply
- Stand-by power supply
- Cellular phones
- PDAs
- Portable electronics
- Notebook PCs

### **Typical Application**

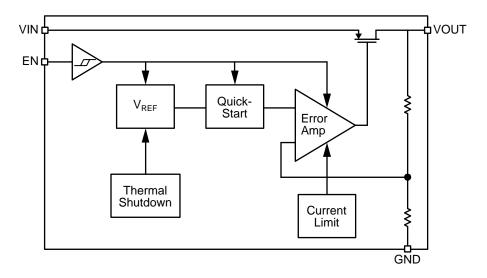




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## **Block Diagram**



# Ordering Information<sup>(1)</sup>

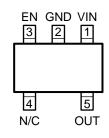
Part Number	Marking Code	Voltage	Temperature Range	Package Lead F	
MIC5307-1.5YD5	<u>QQ</u> 15*	1.5V	–40°C to +125°C	5-Pin TSOT23	Pb-Free
MIC5307-1.8YD5	<u>QQ</u> 18*	1.8V	–40°C to +125°C	5-Pin TSOT23	Pb-Free
MIC5307-2.8YD5	<u>QQ</u> 28*	2.8V	–40°C to +125°C	5-Pin TSOT23	Pb-Free
MIC5307-3.0YD5	<u>QQ</u> 30*	3.0V	–40°C to +125°C	5-Pin TSOT23	Pb-Free
MIC5307-2.8YMT	Q28**	2.8V	–40°C to +125°C	6-Pin 2mm x 2mm Thin $MLF^{\textcircled{8}}$	Pb-Free

Notes

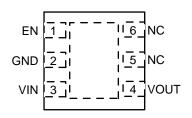
\* Underbar ( \_ ) symbol may not be to scale.

\*\* 2x2mm Thin MLF® is a GREEN RoHS compliant package. Lead finish is NiPdAu. Mold compound is Halogen Free.

### **Pin Configuration**



MIC5307-x.xYD5 5-Pin Thin SOT23 (D5)



MIC5307-x.xYMT 6-Pin 2mm x 2mm Thin  $MLF^{\otimes}$  (MT)

#### **Pin Description**

Pin Number TSOT23	Pin Number Thin MLF <sup>®</sup>	Pin Name	Pin Function
1	3	VIN	Supply Input
2	2	GND	Ground
3	1	EN	Enable Input. Active High. High = on, low = off. Do not leave floating
4	5	NC	No Connect
5	4	VOUT	Output Voltage
_	6	NC	No Connect

## Absolute Maximum Ratings<sup>(1)</sup>

Supply Voltage (V <sub>IN</sub> )	0V to 6V
Enable Input Voltage (V <sub>EN</sub> )	0V to 6V
Enable Input Voltage (V <sub>EN</sub> ) Power Dissipation (P <sub>D</sub> ) <sup>(3)</sup>	Internally Limited
Junction Temperature (T <sub>J</sub> )	40°C to +125°C
Lead Temperature (soldering, 5sec.)	260°C
Storage Temperature (T <sub>s</sub> )	–65°C to +150°C
Storage Temperature (T <sub>s</sub> ) ESD Rating <sup>(4)</sup>	2kV

### **Operating Ratings**<sup>(2)</sup>

Supply voltage (V <sub>IN</sub> )	
Enable Input Voltage	0V to V <sub>IN</sub>
Junction Temperature (T <sub>J</sub> )	–40°C to +125°C
Thermal Resistance	
TSOT23-5 (θ <sub>JA</sub> )	235°C/W
2x2 Thin MLF-6 (θ <sub>JA</sub> )	93°C/W

## Electrical Characteristics<sup>(5)</sup>

 $V_{IN} = V_{OUT} + 1.0V$ ;  $C_{OUT} = 2.2\mu$ F;  $I_{OUT} = 100\mu$ A;  $T_J = 25^{\circ}$ C, **bold** values indicate  $-40^{\circ}$ C to  $+125^{\circ}$ C, unless noted.

Parameter	Condition	Min	Тур	Max	Units
Output Voltage Accuracy	Variation from nominal V <sub>OUT</sub>	-1		+1	%
	Variation from nominal V <sub>OUT</sub> ; –40°C to +125°C	-2		+2	%
Line Regulation	$V_{IN} = V_{OUT} + 1V$ to 5.5V		0.01	0.3	%/V
				0.5	%/V
Load Regulation	I <sub>OUT</sub> = 100µA to 300mA		0.5	1	%
				1.5	%
Dropout Voltage <sup>(4)</sup>	I <sub>OUT</sub> = 50mA		20		mV
	I <sub>OUT</sub> = 100mA		40		mV
	$I_{OUT} = 150 \text{mA}$		60		mV
	I <sub>OUT</sub> = 300mA		120	250	mV
Ground Pin Current	$I_{OUT} = 0$ mA to 150mA; $V_{IN} = 5.5V$		18		μΑ
	$I_{OUT} = 0mA$ to 300mA; $V_{IN} = 5.5V$		20	30	μA
Ground Pin Current in Shutdown	$V_{EN} \le 0.2V; V_{IN} = 5.5V$		0.01	1	μΑ
Ripple Rejection	$f = 10Hz$ to 1kHz; $C_{OUT} = 2.2\mu$ F; $I_{OUT} = 300$ mA		62		dB
	$f = 20kHz; C_{OUT} = 2.2\mu F; I_{OUT} = 300mA$		35		dB
Current Limit	$V_{OUT} = 0V$	350	500	800	mA
Thermal Shutdown			160		°C
Thermal Shutdown Hysteresis			20		°C
Output Voltage Noise	$C_{OUT} = 2.2 \mu F$ ; 10Hz to 100kHz		80		$\mu V_{RMS}$
Enable Input		·			•
Enable Input Voltage	Logic Low			0.2	V
	Logic High	1.0			V
Enable Input Current	$V_{IL} \leq 0.2V$		0.01	1	μA
	 V <sub>IH</sub> ≥ 1.0V		0.01	1	μA
Turn-on Time <sup>(6)</sup>	$C_{OUT} = 2.2 \mu F$		270	500	μs

Notes:

1. Exceeding the absolute maximum rating may damage the device.

2. The device is not guaranteed to function outside its operating rating.

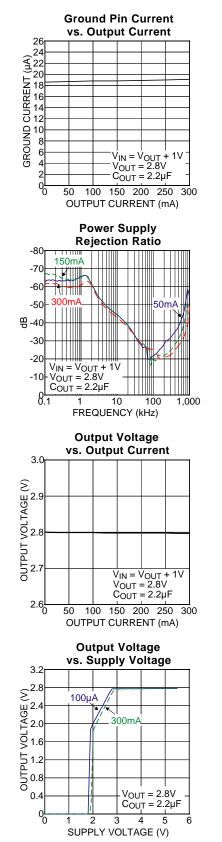
3. The maximum allowable power dissipation of any  $T_A$  (ambient temperature) is  $P_{D(max)} = T_{J(max)} - T_A / \theta_{JA}$ . Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown.

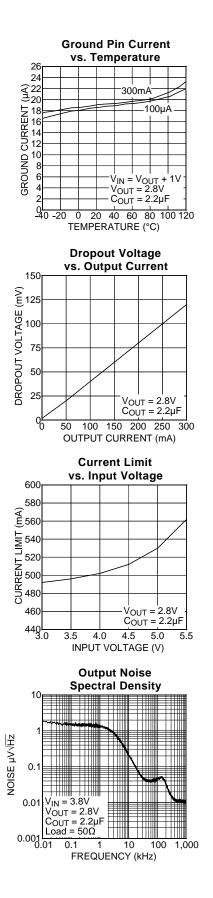
4. Devices are ESD sensitive. Handling precautions recommended.

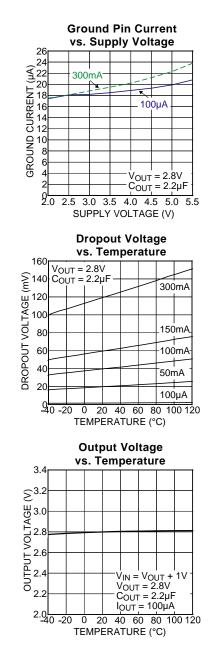
5. Specification for packaged product only.

6. Turn-on time is measured from  $V_{EN} = 1V$  of the positive edge of the enable signal to 90% of the rising edge of the output voltage of the regulator.

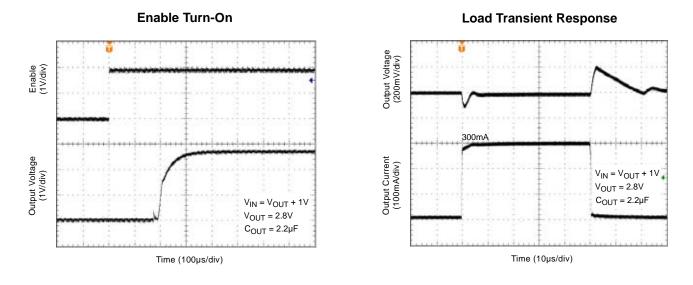
### **Typical Characteristics**



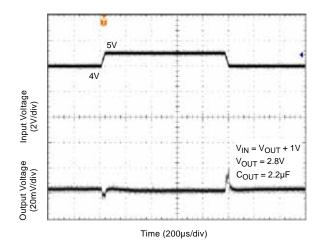




### **Functional Characteristics**



Line Transient Response



### **Application Information**

#### Input Capacitance

A  $1\mu$ F capacitor should be placed from IN to GND if there is more than 10 inches of wire between the input and the ac filter capacitor or if a battery is used as the input.

#### **Output Capacitance**

The MIC5307 requires an output capacitor of  $2.2\mu$ F or greater to maintain stability. The design is optimized for use with low-ESR ceramic chip capacitors. High ESR capacitors may cause high frequency oscillation. The output capacitor can be increased, but performance has been optimized for a  $2.2\mu$ F ceramic output capacitor and does not improve significantly with larger capacitance.

ceramic X7R/X5R dielectric-type capacitors are recommended because of their temperature performance. X7R-type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60%, respectively, over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric, the value must be much higher than an X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

#### Enable

Forcing EN (enable/shutdown) high (>1V) enables the regulator. EN is compatible with CMOS logic gates. If the enable/shutdown feature is not required, connect EN (pin 3) to IN (supply input, pin 1).

#### **Current Limit**

There is overcurrent protection circuitry built into the MIC5307. Even with the output grounded, current will be limited to approximately 500mA. Further protection is provided by thermal shutdown.

#### **Thermal Considerations**

The MIC5307 is designed to provide 300mA of continuous current in a very small package. Maximum ambient operating temperature can be calculated based on the output current and the voltage drop across the part. Given that the input voltage is 3.8V, the output voltage is 2.8V and the output current equals 300mA.

The actual power dissipation of the regulator circuit can be determined using the equation:

$$\mathsf{P}_\mathsf{D} = (\mathsf{V}_\mathsf{IN} - \mathsf{V}_\mathsf{OUT}) \ \mathsf{I}_\mathsf{OUT} + \mathsf{V}_\mathsf{IN} \ \mathsf{I}_\mathsf{GND}$$

MIC5307

Because this device is CMOS and the ground current is typically  $< 50\mu$ A over the load range, the power dissipation contributed by the ground current is < 1% and can be ignored for this calculation.

$$P_{D} = (3.8V - 2.8V) \cdot 300mA$$
  
 $P_{D} = 0.3W$ 

To determine the maximum ambient operating temperature of the package, use the junction-to-ambient thermal resistance of the device and the following basic equation:

$$P_D(max) = \frac{T_J(max) - T_A}{\theta_{JA}}$$

 $T_J(max)$  = 125°C, the maximum junction temperature of the die  $\theta_{JA}$  thermal resistance = 235°C/W

Table 1 shows junction-to-ambient thermal resistance for the MIC5307 in the TSOT23-5 package.

Package	θ <sub>JA</sub> Recommended Minimum Footprint
TSOT23-5	235°C/W

 Table 1. TSOT23-5 Thermal Resistance

Substituting  $P_D$  for  $P_D$  (max) and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit. The junction-toambient thermal resistance for the minimum footprint is 235°C/W, from Table 1. The maximum power dissipation must not be exceeded for proper operation.

For example, when operating the MIC5307-2.8 at an input voltage of 3.8V and 300mA load with a minimum footprint layout, the maximum ambient operating temperature  $T_A$  can be determined as follows:

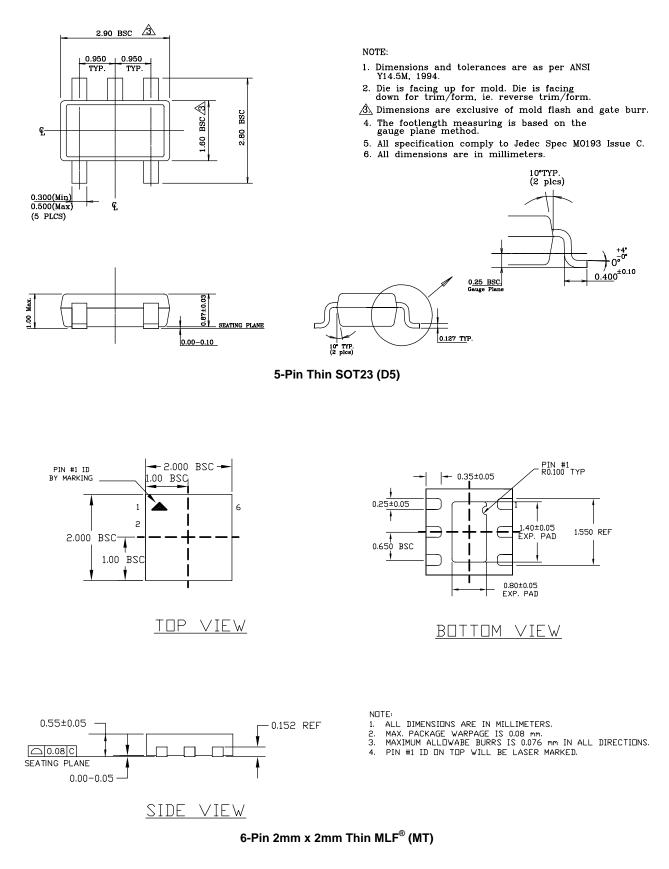
 $0.3W = (125^{\circ}C - T_{A}) / 235C^{\circ}/W$ 

$$T_{A} = 54.5^{\circ}C$$

Therefore, a 2.8V application at 300mA of output current can accept an ambient operating temperature of 89.8°C in a TSOT23-5 package. For a full discussion of heat sinking and thermal effects on voltage regulators, refer to the "Regulator Thermals" section of Micrel's *Designing with Low-Dropout Voltage Regulators* handbook. This information can be found on Micrel's website at:

http://www.micrel.com/\_PDF/other/LDOBk\_ds.pdf

### **Package Information**



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